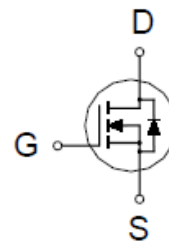
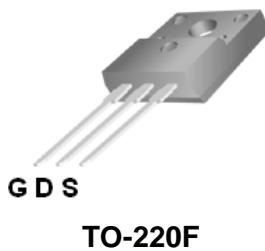


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PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
600V	$0.65\Omega @ V_{GS} = 10V$	12A



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	600	V
Gate-Source Voltage		V_{GS}	± 30	
Continuous Drain Current ²	$T_C = 25\text{ }^\circ\text{C}$	I_D	12	A
	$T_C = 100\text{ }^\circ\text{C}$		8.5	
Pulsed Drain Current ^{1,2}		I_{DM}	48	
Avalanche Current ³		I_{AS}	7.4	
Avalanche Energy ³	$L = 10\text{mH}$	E_{AS}	277	mJ
Power Dissipation ^A	$T_C = 25\text{ }^\circ\text{C}$	P_D	50	W
	$T_C = 100\text{ }^\circ\text{C}$		20	
Operating Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		0.56	$^\circ\text{C} / \text{W}$
Junction-to-Ambient	$R_{\theta JA}$		62.5	

¹Pulse width limited by maximum junction temperature.

²Limited only by maximum temperature allowed.

³ $V_{DD} = 60V$, Starting $T_J = 25^\circ\text{C}$

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	600			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	2.5		4.5	V
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±30V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 600V, V _{GS} = 0V, T _C = 25 °C			25	μA
		V _{DS} = 600V, V _{GS} = 0V, T _C = 100 °C			250	
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 10V, I _D = 6A		0.475	0.650	Ω
Forward Transconductance ¹	g _{fs}	V _{DS} = 40V, I _D = 6A		16		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz		2290		pF
Output Capacitance	C _{oss}			281		
Reverse Transfer Capacitance	C _{rss}			46		
Total Gate Charge ²	Q _g	V _{DS} = 300V, V _{GS} = 10V, I _D = 6A		46.5		nC
Gate-Source Charge ²	Q _{gs}			10		
Gate-Drain Charge ²	Q _{gd}			16.1		
Turn-On Delay Time ²	t _{d(on)}	V _{DD} = 300V, I _D = 6A, R _G = 25Ω		35		nS
Rise Time ²	t _r			120		
Turn-Off Delay Time ²	t _{d(off)}			115		
Fall Time ²	t _f			90		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current ³	I _S				12	A
Forward Voltage ¹	V _{SD}	I _F = 8A, V _{GS} = 0V			1.4	V
Reverse Recovery Time	t _{rr}	I _F = 12A, di _F /dt = 100A / μS, V _{GS} = 0V		420		nS
Reverse Recovery Charge	Q _{rr}				4.7	

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

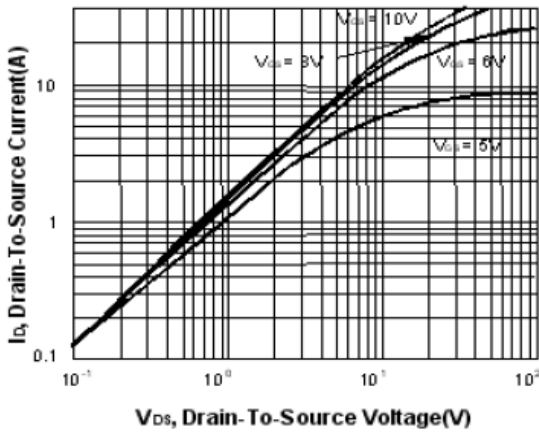
²Independent of operating temperature.

³Pulse width limited by maximum junction temperature.

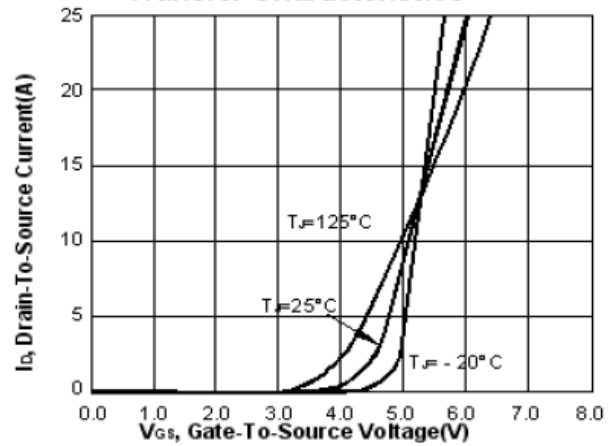
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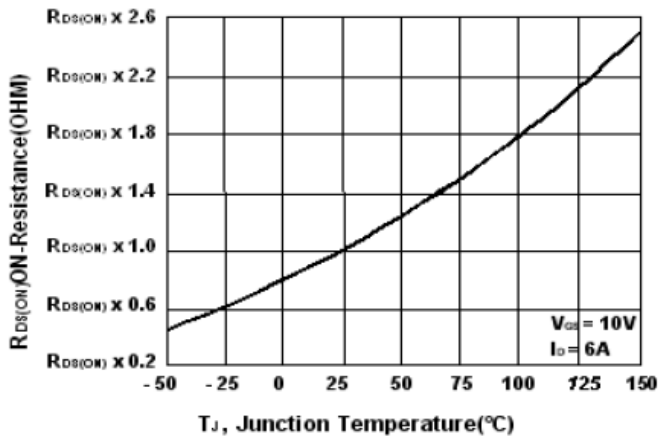
Output Characteristics



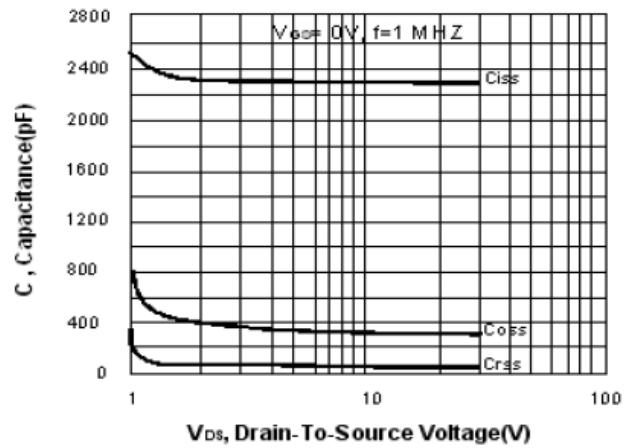
Transfer Characteristics



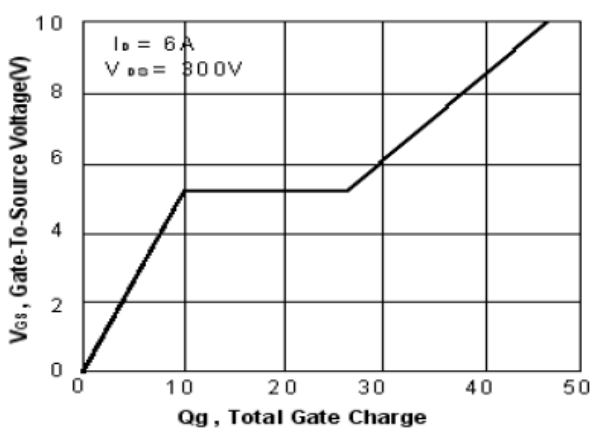
On-Resistance VS Temperature



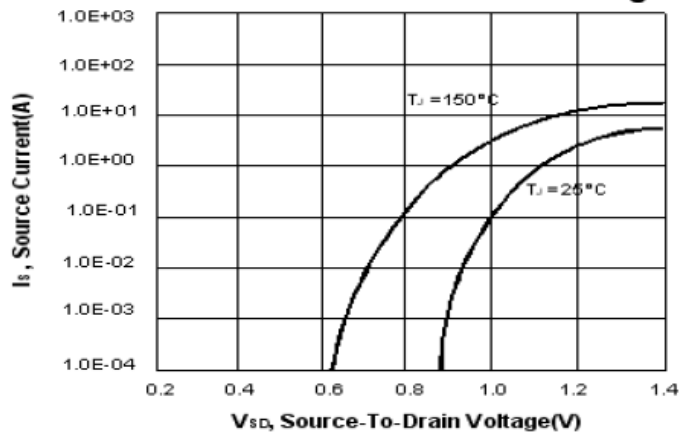
Capacitance Characteristic



Gate charge Characteristics



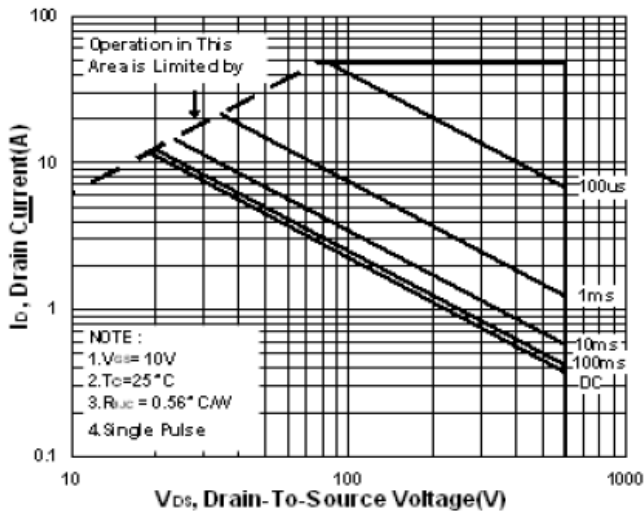
Source-Drain Diode Forward Voltage



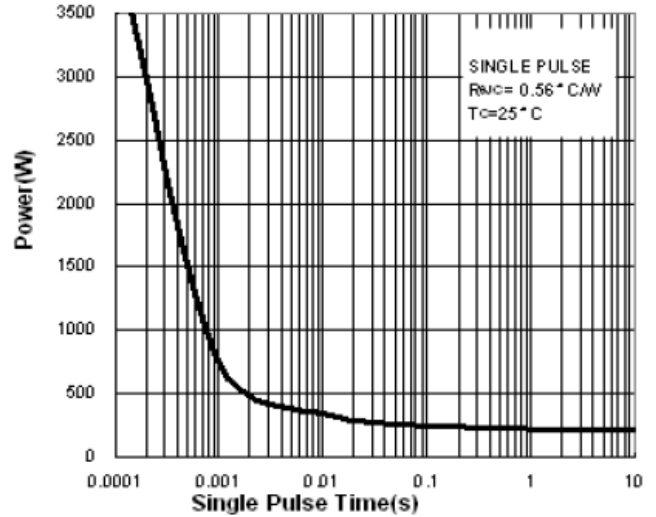
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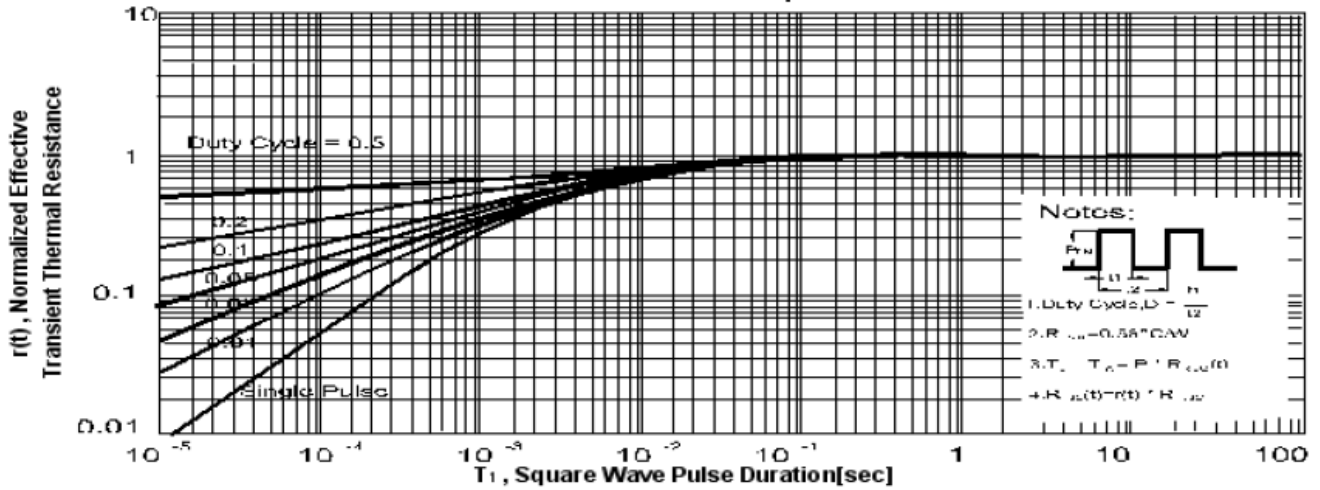
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



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Package Dimension

TO-220F (3-Lead) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.2		4.93	e	2.05	2.55	3.05
A1	2.34		3.1	F	27.45		30.6
B	17.77		20.3	G	7.72		9.3
b	0.6		1.05	H	6.1		7.1
b1	0.9	1.23	1.62	L	12.5		14.5
b2	0.6		1.9	L1	1.97		3.8
c	0.4		1.0	P	2.98		3.4
D	14.7		16.4	Q	2.1		2.96
D1	6.4		7.5	q	3.0		3.8
E	9.7		10.4				

